



SPECIFICATION

- · Supplier : Samsung electro-mechanics
- Product : Multi-layer Ceramic Capacitor
- · Samsung P/N :
- CL03A224KQ3NNNH

(Reference sheet)

- Description :
- CAP, 220nF, 6.3V, ±10%, X5R, 0201

A. Samsung Part Number

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1	Series	Samsung Multi-layer Ceramic Capacitor								
2	Size	0201 (inch cod	e)	L: 0.6	0 ± 0.03	3 mm			W:	0.30 ± 0.03 mm
3	Dielectric	X5R		(8	Inne	r elect	trode			Ni
4	Capacitance	220 nF			Term	ninatio	on			Cu
5	Capacitance	±10 %			Plati	ng				Sn 100% (Pb Free)
	tolerance			9	Prod	uct				Normal
6	Rated Voltage	6.3 V		10	Spec	ial				Reserved for future use
1	Thickness	0.30 ± 0.03 mm		I	Pack	aging	I			Cardboard Type, 7" reel

B. Structure & Dimension



Samsung P/N	Dimension(mm)							
Samsung F/N	L	W	Т	BW				
CL03A224KQ3NNNH	0.60 ± 0.03	0.30 ± 0.03	0.30 ± 0.03	0.15 ± 0.05				

C. Samsung Reliablility Test and Judgement Condition

	Judgement	Test condition				
Capacitance	Within specified tolerance	1 ^{kHz} ±10% / 0.5±0.1Vrms				
Tan δ (DF)	0.1 max.	*A capacitor prior to measuring the capacitance is heat treated at $150^{\circ}C+0/-10^{\circ}C$ for 1 hour and maintained in ambient air for 24±2 hours.				
Insulation	10,000Mohm or 100Mohm× <i>μ</i> F	Rated Voltage 60~120 sec.				
Resistance	Whichever is smaller					
Appearance No abnormal exterior appearance		Microscope (×10)				
Withstanding	No dielectric breakdown or	250% of the rated voltage				
Voltage	mechanical breakdown					
Temperature	X5R					
Characteristics	(From-55 ℃ to 85 ℃, Capacitance change s	hould be within ±15%)				
Adhesive Strength	No peeling shall be occur on the	200g f, for 10±1 sec.				
of Termination	terminal electrode					
Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (1mm)				
		with 1.0mm/sec.				
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder				
	is to be soldered newly	245±5℃, 3±0.3sec.				
		(preheating : 80~120°C for 10~30sec.)				
Resistance to	Capacitance change : within ±7.5%	Solder pot : 270±5°C, 10±1sec.				
Soldering Heat	Tan δ, IR : initial spec.					
Vibration Test	Capacitance change : within $\pm 5\%$ Tan δ , IR : initial spec.	Amplitude : 1.5mm From 10Hz to 55Hz (return : 1min.) 2hours × 3 direction (x, y, z)				
Moisture	Capacitance change : within ±12.5%	With rated voltage				
Resistance	Tan δ : 0.2 max	40±2℃, 90~95%RH, 500+12/-0hrs				
	IR : 500Mohm or 12.5Mohm × μ F					
	Whichever is smaller					
High Temperature	Capacitance change : within ±12.5%	With 150% of the rated voltage				
Resistance	Tan δ : 0.2 max	Max. operating temperature				
	IR : 1,000Mohm or 25Mohm × <i>μ</i> F	1000+48/-0hrs				
	Whichever is smaller					
Temperature	Capacitance change : within ±7.5%	1 cycle condition				
Cycling	Tan δ, IR : initial spec.	Min. operating temperature \rightarrow 25°C				
		\rightarrow Max. operating temperature \rightarrow 25°C				
		5 cycle test				

X The reliability test condition can be replaced by the corresponding accelerated test condition.

D. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 260±5°C, 30sec.)

A Product specifications included in the specifications are effective as of March 1, 2013. Please be advised that they are standard product specifications for reference only.

We may change, modify or discontinue the product specifications without notice at any time.

So, you need to approve the product specifications before placing an order.

Should you have any question regarding the product specifications,

please contact our sales personnel or application engineers.

Disclaimer & Limitation of Use and Application

The products listed in this Specification sheet are **NOT** designed and manufactured for any use and applications set forth below.

Please note that any misuse of the products deviating from products specifications or information provided in this Spec sheet may cause serious property damages or personal injury. We will **NOT** be liable for any damages resulting from any misuse of the products, specifically including using the products for high reliability applications as listed below.

If you have any questions regarding this 'Limitation of Use and Application', you should first contact our sales personnel or application engineers.

- *①* Aerospace/Aviation equipment
- 2 Automotive or Transportation equipment (vehicles, trains, ships, etc)
- 3 Medical equipment
- (4) Military equipment
- 5 Disaster prevention/crime prevention equipment
- Ø Power plant control equipment
- ⑦ Atomic energy-related equipment
- Indersea equipment
- Itraffic signal equipment
- Data-processing equipment
- ① Electric heating apparatus, burning equipment
- ② Safety equipment
- 13 Any other applications with the same as or similar complexity or reliability to the applications